CXG1006N

High-Frequency SPDT Antenna Switch

 $V_{CTL}(H) = 4.0V$

Description

The CXG1006N is a high power antenna switch MMIC. This IC is designed using the Sony's GaAs J-FET process and operates at a single positive power supply.

Features

- Single positive power supply operation
- Low insertion loss 0.5dB (Typ.) at 2.0GHz
- High isolation 27dB (Typ.) at 2.0GHz
- High power switching

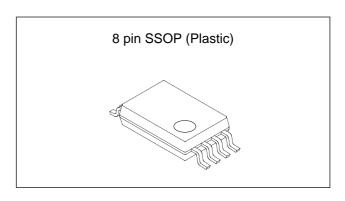
P1dB (Typ.) 32dBm at 2.0GHz VcTL (H) = 2.0V 34dBm at 2.0GHz

Application

Antenna switch for digital cellular telephones

Structure

GaAs J-FET MMIC



Absolute Maximum Ratings (Ta = 25°C)

 Control voltage 	Vctl	7	V
• Operating temperature	Topr	-35 to +85	°C
Storage temperature	Tstg	-65 to +150	°C

Operating Condition

Control voltage 0/4 V

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Electrical Characteristics

VCTL (L) = 0V, VCTL (H) = 4V, PIN = 30dBm, RRF = $75k\Omega$

 $(Ta = 25^{\circ}C)$

Item	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Insertion Loss	IL1	f = 1.0GHz		0.3	0.6	dB
Isolation	ISO1	T = 1.0GHZ	35	40		dB
Insertion Loss	IL1.5	f 4.50U-		0.4	0.7	dB
Isolation	ISO1.5	f = 1.5GHz	29	32		dB
Insertion Loss	IL2			0.5	0.8	dB
Isolation	ISO2	f = 2.0GHz	24	27		dB
VSWR	VSWR				1.5	
Switching Time	TSW			100		ns

VCTL(L) = 0V, f = 2GHz

 $(Ta = 25^{\circ}C)$

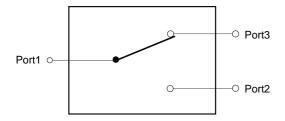
Item	Symbol	Test Condition	Min.	Тур.	Max.	Unit
1dB Compression Point	P1dB (3)	Vсть (H) = 3V	30	32		dBm
1dB Compression Point	P1dB (4)	VCTL (H) = 4V	32	34		dBm

Vctl (L) = 0V, Rrf = $75k\Omega$

 $(Ta = 25^{\circ}C)$

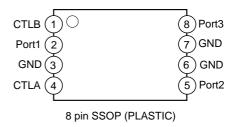
Item	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Control Current	Ість (1)	Vctl (H) = 3V		100	170	μA
Control Current	ICTL (2)	Vctl (H) = 4V		150	220	μA
Control Current	Ість (3)	Vctl (H) = 5V		200	270	μA

Block Diagram



Vctla	Vстlв	
High	Low	Port1-Port2 ON Port1-Port3 OFF
Low	High	Port1-Port2 OFF Port1-Port3 ON

Package Outline/Pin Configulation



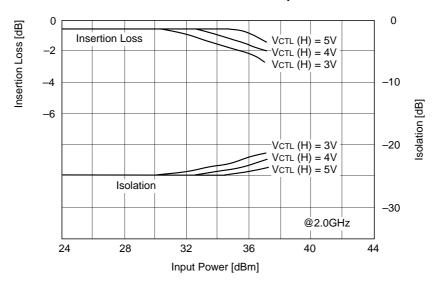
Recommended Circuit



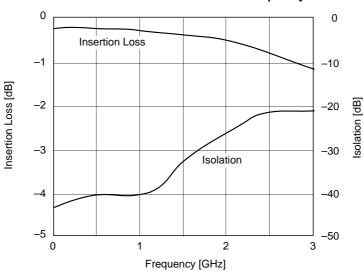
^{*} RRF is used to stabilize the electrical characteristics at high power signal input

Example of Representive Characteristics (Ta = 25°C)

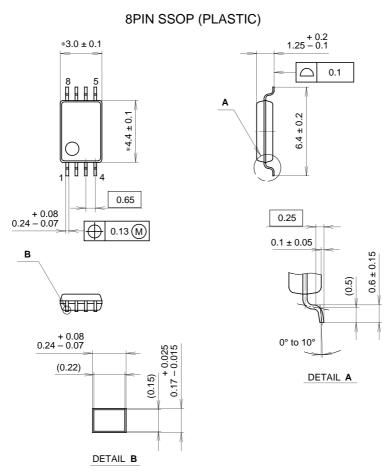
Insertion Loss and Isolation vs. Input Power



Insertion Loss and Isolation vs. Frequency



Package Outline Unit: mm



NOTE: Dimension "*" does not include mold protrusion.

SONY CODE	SSOP-8P-L01
EIAJ CODE	SSOP008-P-0044
JEDEC CODE	

PACKAGE STRUCTURE

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER / PALLADIUM PLATING
LEAD MATERIAL	COPPER ALLOY
PACKAGE WEIGHT	0.04g